

Product Data Sheet

Acrich2 - 12.7W

RoHS

Integrated AC LED Solution

Acrich2 – 12.7W Eco

SMJE-XV12W2P4



Product Brief

Description

The Acrich2 series of products are designed to be driven directly off the AC line voltage (with an SPC board) and do not need the typical AC/DC converters essential for conventional lighting products.

The converter or the driver found in most general lighting products can limit the overall life of the product, but with the Acrich2 series the lifetime of the product is based on the lifetime of the LED itself.

The Acrich2 series also allows for maximum design flexibility to create a compact and aesthetic luminaire.

The modules also have a high power factor which can contribute to additional energy savings in the end application.

Table 1. Product Selection (CCT)

Features and Benefits

- Connects directly to AC line voltage through a Surge Protection circuit (SPC2.5)
- High Power Factor and Low THD
- Long Life Time with Simple BOM
- Miniaturization
- Lead Free Product
- RoHS Compliant

Key Applications

- Bulb light
- Down light

	· · · · · · · · · · · · · · · · · · ·				
Part No.	Vin [Vac]		Color		CRI
Fait NO.	viii [vac]	P [W]	COIOI	ССТ [К]	Min.
			Cool	4700 – 6000	
SMJE-2V12W2P4	120		Neutral	3700 - 4200	
		10.7	Warm	2600 – 3200	00
		12.7	Cool	4700 – 6000	80
SMJE-3V12W2P4	220		Neutral	3700 - 4200	
			Warm	2600 – 3200	

Table 2. Product Selection (Flux)

Dort No.			Elux Bin	Flux	[lm]
Part No.	Vin [Vac]	P [W]	Flux Bin	Min.	Тур.
SMJE-2V12W2P4	120	12.7		950	020
SMJE-3V12W2P4	220	12.7	-	850	930



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Performance Characteristics

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Table 3. Electro Optical Characteristics, $T_a = 25^{\circ}C$

Deremeter	Cumhal		Value	Value		Mark
Parameter	Symbol	Min.	Тур.	Max.	Unit	Wark
Luminous Flux	$\Phi_V^{[2]}$	850	930	-	lm	-
		5300	5600	6000		В
		4700	5000	5300		С
Correlated Color Temperature ^[3]	ССТ	3700	4000	4200	- -	E
		2900	3000	3200		G
		2600	2700	2900		н
CRI	Ra	80	-	-	-	
Innut Valtana [4]			120			2V
Input Voltage ^[4]	V _{in}	220			Vac	3V
Power Consumption	Р	12.0	12.7	13.3	W	12W
Operating Frequency	f		50 / 60		Hz	
Power Factor	PF		Over 0.97		-	
Viewing Angle	2Θ _{1/2}		120		deg.	

Notes :

- (1) At 120Vac/220Vac, $T_a = 25^{\circ}C$
- (2) Φ_V is the total luminous flux output measured with an integrated sphere.
- (3) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.
- (4) Operating Voltage doesn't indicate the maximum voltage which customers use but means tolerable voltage according to each country's voltage variation rate. It is recommended that the solder pad temperature should be below 70 ℃.

Absolute Maximum Ratings

Table 4. Absolute Maximum Ratings, $T_a = 25^{\circ}C$

Parameter	Symbol	Unit	Value
Maximum Input Voltage @120Vac			140
Maximum Input Voltage @220Vac	· V _{in}	Vac	264
Power Consumption	Р	W	17.5
Operating Temperature	T _{opr}	°C	-30 ~ 85
Storage Temperature	T _{stg}	°C	-40 ~ 100
ESD Sensitivity	-	-	±4,000V HBM



Thermal Resistance

Part	Package Power Dissipation [W]	Maximum Junction Temperature [℃]	Rθ _{j-s} [℃/W]
Acrich2 LED	SAW8WA2A Max 1.55	125	23
Acrich2 IC	Max 1.0	150	11.25

The Acrich2 LED has a thermal resistance of 23 $^\circ\!C/W$ from junction of the LED to the

LED lead.

The maximum junction temperature of the Acrich2 LED package is 125 $^\circ\!\!\!C$, therefore the maximum lead temperature T_{s_max} is

$$T_{s_{max}} = T_{j_{max}} - (R\theta_{j-s} * P_d)$$

= 125 °C - (23 °C/W * 1.55W) = 89.35 °C

Although this is the maximum lead temperature, it is recommended to keep the lead temperature under 70 °C.

The Acrich2 IC has a 11.25 °C/W thermal resistance from junction to the top surface.

The maximum junction temperature (T $_{\rm j\ max}$) of the IC is 150 $^\circ\!{\rm C}$, therefore the maximum

temperature of the top of the IC is

$$T_{t_{max}} = T_{j_{max}} - (R\theta_{j_{t}} * P_{d})$$

= 150 °C - (11.25 °C/W * 1.0W) = 138.75 °C

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Relative Spectral Distribution

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Fig 1. Relative Spectral Distribution vs. Wavelength Characteristic - G, H

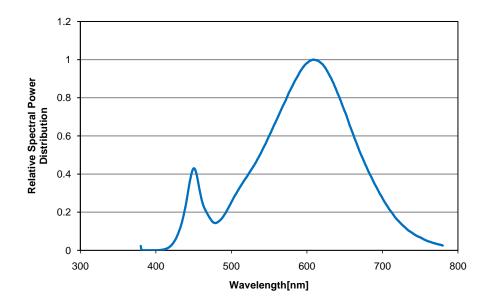
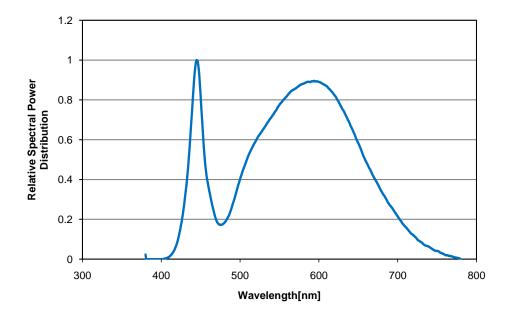


Fig 2. Relative Spectral Distribution vs. Wavelength Characteristic – E

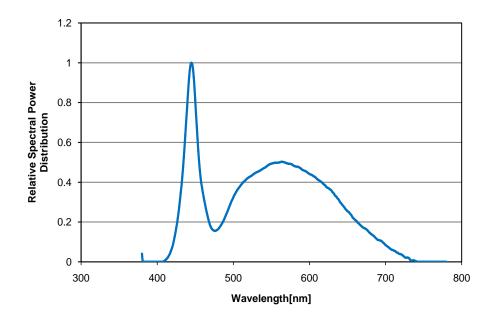


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Relative Spectral Distribution

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Fig 3. Relative Spectral Distribution vs. Wavelength Characteristic - B, C



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Relative Power Distribution

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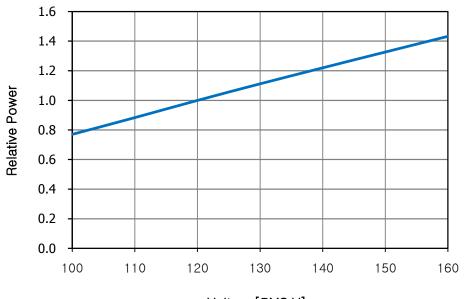
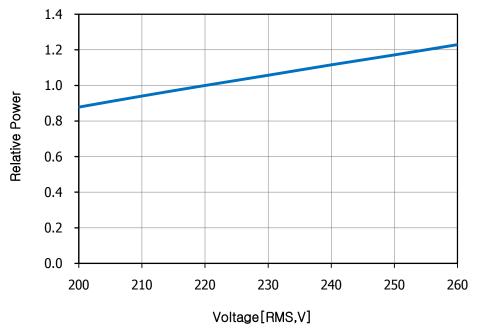


Fig 4. Relative Power Distribution vs. Voltage at $T_a = 25 \,^{\circ}\text{C}$, 120V







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Relative Luminous Distribution

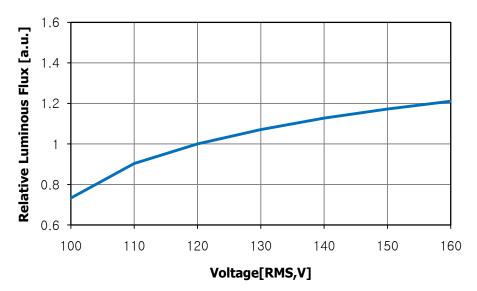
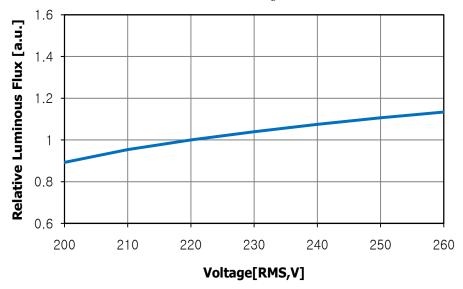


Fig 6. Relative Luminous Flux vs. Voltage at $T_a = 25 \degree$, 120V

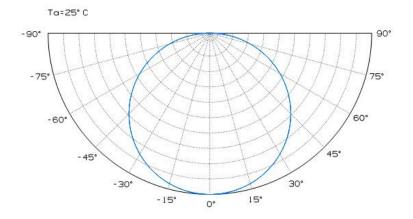
Fig 7. Relative Luminous Flux vs. Voltage at $\rm T_a$ =25 $^\circ\!C$, 220V





Luminous Flux Characteristics

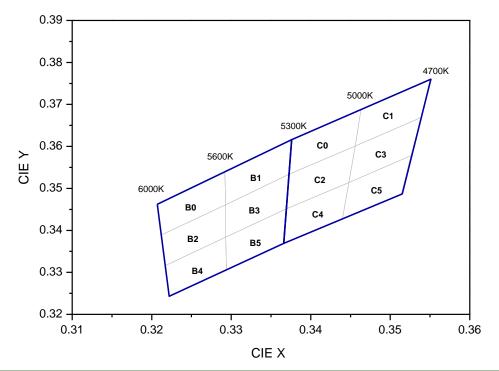
Fig 8. Radiant Pattern, $T_a = 25 ^{\circ}C$



Color Bin Structure

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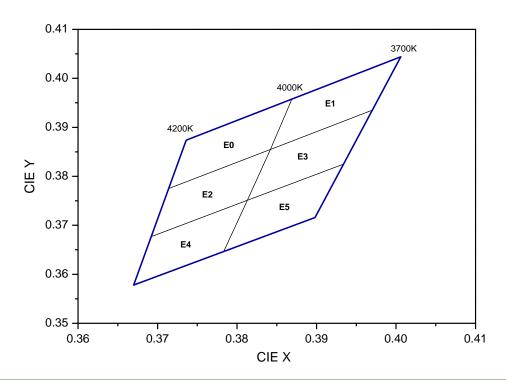
CIE Chromaticity Diagram



Bin code	х	Y	Bin code	x	Y	Bin code	x	Y
	0.3207	0.3462		0.3292	0.3539		0.3212	0.3389
B0 -	0.3212	0.3389	- B1	0.3293	0.3461	B2	0.3217	0.3316
	0.3293	0.3461	ы	0.3373	0.3534	DZ	0.3293	0.3384
	0.3292	0.3539		0.3376	0.3616		0.3293	0.3461
	0.3293	0.3461	_	0.3217	0.3316		0.3293	0.3384
B3 -	0.3293	0.3384	- B4	0.3222	0.3243	B5	0.3294	0.3306
D3	0.3369	0.3451	D4	0.3294	0.3306	Э 	0.3366	0.3369
	0.3373	0.3534	-	0.3293	0.3384		0.3369	0.3451
	0.3376	0.3616		0.3463	0.3687		0.3373	0.3534
C0 -	0.3373	0.3534	- C1	0.3456	0.3601	- C2	0.3369	0.3451
0	0.3456	0.3601	UI I	0.3539	0.3669	02	0.3448	0.3514
	0.3463	0.3687		0.3552	0.3760		0.3456	0.3601
	0.3456	0.3601		0.3369	0.3451		0.3448	0.3514
C3 -	0.3448	0.3514	- C4	0.3366	0.3369	C E	0.3440	0.3428
	0.3526	0.3578	- 04	0.3440	0.3428	C5	0.3514	0.3487
	0.3539	0.3669		0.3448	0.3514		0.3526	0.3578



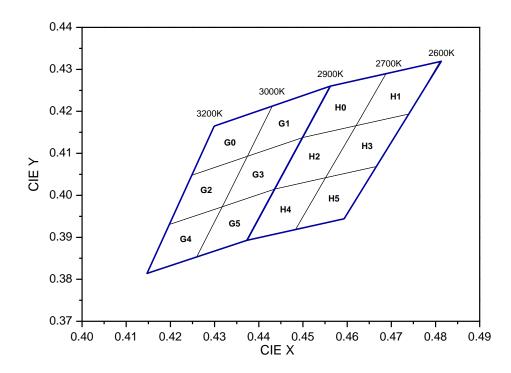
Color Bin Structure



Bin code	x	Y	Bin code	x	Y	Bin code	x	Y
	0.3736	0.3874		0.3869	0.3958		0.3714	0.3775
E0 ·	0.3714	0.3775	E1	0.3842	0.3855	E2	0.3692	0.3677
	0.3841	0.3855		0.3970	0.3935	E2	0.3813	0.3751
	0.3869	0.3958	-	0.4006	0.4044		0.3842	0.3855
	0.3842	0.3855		0.3692	0.3677		0.3813	0.3751
E3 ·	0.3813	0.3751	E4	0.3670	0.3578	E5	0.3783	0.3646
	0.3934	0.3825	⊑4	0.3783	0.3646	E0	0.3898	0.3716
	0.3970	0.3935	-	0.3813	0.3751		0.3934	0.3825



Color Bin Structure



Bin code	х	Y	Bin code	x	Y	Bin code	x	Y
	0.4299	0.4165		0.4430	0.4212		0.4248	0.4048
G0 -	0.4248	0.4048	- G1	0.4374	0.4093	G2	0.4198	0.3931
GU	0.4374	0.4093	GI	0.4499	0.4138	G2	0.4317	0.3973
	0.4430	0.4212		0.4562	0.4260		0.4374	0.4093
	0.4374	0.4093		0.4198	0.3931		0.4317	0.3973
G3 ·	0.4317	0.3973	- G4	0.4147	0.3814	G5	0.4259	0.3853
63	0.4436	0.4015	G4	0.4259	0.3853	Go	0.4373	0.3893
	0.4499	0.4138		0.4317	0.3973		0.4436	0.4015
	0.4562	0.4260		0.4687	0.4289		0.4499	0.4138
H0 -	0.4499	0.4138	- H1 ·	0.4620	0.4166	H2	0.4436	0.4015
	0.4620	0.4166		0.4740	0.4194	П2	0.4551	0.4042
	0.4687	0.4289		0.4810	0.4319		0.4620	0.4166
	0.4620	0.4166		0.4436	0.4015		0.4551	0.4042
Н3 -	0.4551	0.4042	-	0.4373	0.3893		0.4483	0.3919
	0.4666	0.4069	- H4 ·	0.4483	0.3919	H5	0.4593	0.3944
	0.4740	0.4194		0.4551	0.4042	-	0.4666	0.4069



Part List

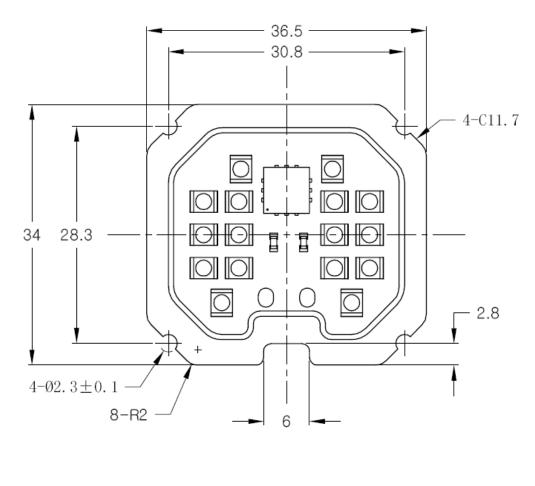
Table 5. Part List

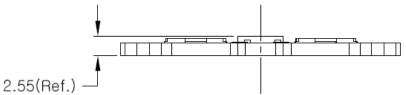
No	Part	Reference	Specification	Quantity
1	PCB	-	Al, 36.5*34.0(mm), T=1.6, 1 layer / Cu 1oz / White PSR	1
2	LED	-	SAW8WA2A	16
	10	10	DT3001B @120Vac	1
3	IC	IC	DT3001A @220Vac	1
		54	R1608, 2.49kΩ, 1%(F) @120Vac	1
4	Resistor	R1	R1608, 1.3kΩ, 1%(F) @220Vac	1
5		R2	R1608, 1kΩ, 1%(F)	1



Acrich2 - 12.7W

Mechanical Dimensions





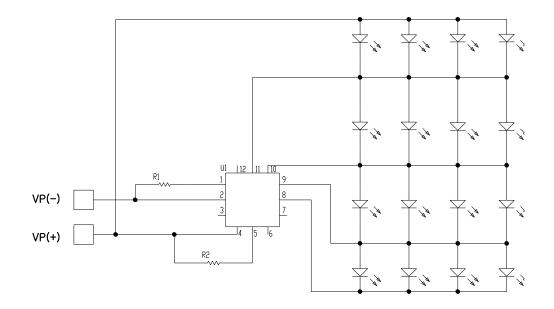
Notes :

- (1) All dimensions are in millimeters. (Tolerance : ± 0.2)
- (2) Undefined R1
- (3) Scale : None



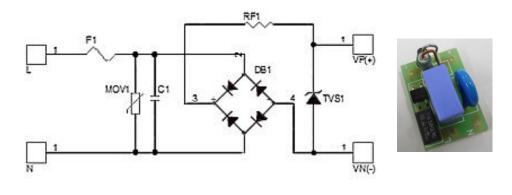
Circuit Drawing

Acrich module



(SMJE-2V12W2P4)

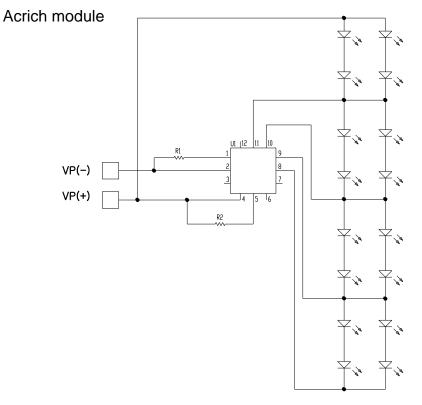
Surge Protection Circuit 2.5 (Additional daughter board)



(SMJJ-SPCR0AC2.5)

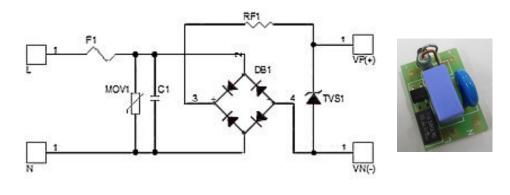


Circuit Drawing



(SMJE-3V12W2P4)

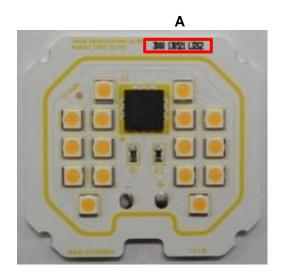
Surge Protection Circuit 2.5 (Additional daughter board)



(SMJJ-SPCR0AC2.5)

Marking Information

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A : Marking

ex) <u>XX00</u> <u>YYMMDD</u> <u>L32G2</u> 1 2 3 4

- ① CCT (4 Digits)
- ② SMT Date (YYMMDD, 6 Digits)
- ③ LED PKG. Luminous Intensity Bin (3 Digits)
- ④ LED PKG. Color Bin (2 Digits)
- XX00 : CCT
 - H Rank : 2700
 - G Rank : 3000
 - E Rank : 4000
 - C Rank : 5000
 - B Rank : 5600



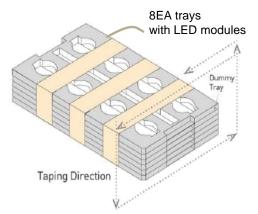
Packing

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1. Tray information

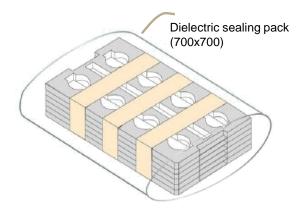


- 40 PCS LED modules packed per tray
- 2. Tray stack and taping

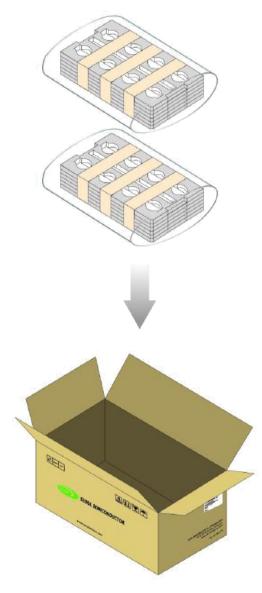


• 8 LED module trays and additional 2 dummy trays each up and down of box (* 300 PCS modules are packed by 1 sealing pack.)

- Add silica gel (1EA) on top of the tray
- 3. Sealing packing



4. Box information & packing



- 600 PCS modules per BOX 1EA
- ** 1 Box : 40 PCS per tray x 16 trays = 600 PCS

Label Information

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Model No.	SMJE-XV12W2P4 ⁽¹⁾
Rank	ALLX06A ⁽²⁾
Туре	STD ⁽³⁾
Quantity	
Lot No.	
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Notes

- (1) The model number designation is explained as follow SMJE : Seoul Semiconductor internal code XV : Input Voltage (2V = 120V, 3V = 220V) 12W : About Power Consumption 2 : Acrich IC Version P4 : MJT PKG (SAW8WA2A)
- (2) It represents the LED module rank.
 ALL : Single Bin
 X06 : Each Sub-Bin NO. (X = CCT)
 A : Single Bin
- (3) It represents single bin(STD).
- (4) It is attached to the top of a sealing pack & the bottom right corner of the box.

T	OTAL Quantity
	XX
SEOUL	SEOUL SEMICONDUCTOR CO.,LTD.

Notes

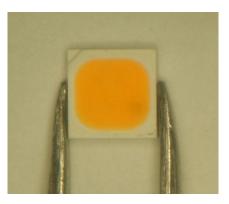
(1) It is attached to the bottom right corner of the box.

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Handling of Silicone Resin for LEDs





- (1) Acrich2 series is encapsulated with silicone resin for high optical efficiency.
- (2) Please do not touch the silicone resin area with sharp objects such as pincette(tweezers).
- (3) Finger prints on silicone resin area may affect the performance.
- (4) Please store LEDs in covered containers to prevent dust accumulation as this may affect performance.
- (5) Excessive force more than 3000gf to the silicone lens can result in fatal or permanent damage with LEDs.
- (6) Please do not cover the silicone resin area with any other resins such as epoxy, urethane, etc.

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Precaution for Use

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- (1) Please review the Acrich2 Application Note for proper protective circuitry usage.
- (2) Please note, Acrich2 products run off of high voltage, therefore caution should be taken when working near Acrich2 products.
- (3) Make sure proper discharge prior to starting work.
- (4) DO NOT touch any of the circuit board, components or terminals with body or metal while circuit is active.
- (5) Please do not add or change wires while Acrich2 circuit is active.
- (6) Long time exposure to sunlight or UV can cause the lens to discolor.
- (7) Please do not use adhesives to attach the LED that outgas organic vapor.
- (8) Please do not use together with the materials containing Sulfur.
- (9) Please do not assemble in conditions of high moisture and/or oxidizing gas such as CI, H₂S, NH₃, SO₂, NO_x, etc.
- (10) Please do not make any modification on module.
- (11) Please be cautious when soldering to board so as not to create a short between different trace patterns.
- (12) Do not impact or place pressure on this product because even a small amount of pressure can damage the product. The product should also not be placed in high temperatures, high humidity or direct sunlight since the device is sensitive to these conditions.
- (13) When storing devices for a long period of time before usage, please following these guidelines:
 * The devices should be stored in the anti-static bag that it was shipped in from Seoul-Semiconductor with opening.
 - * If the anti-static bag has been opened, re-seal preventing air and moisture from being present in the bag.
- (14) LEDs and IC are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS). The Acrich2 product should also not be installed in end equipment without ESD protection. Below is a list of suggestions that Seoul Semiconductor purposes to minimize these effects.
- a. ESD (Electro Static Discharge)

Electrostatic discharge (ESD) is the defined as the release of static electricity when two objects come into contact. While most ESD events are considered harmless, it can be an expensive problem in many industrial environments during production and storage. The damage from ESD to an LEDs may cause the product to demonstrate unusual characteristics such as:



Precaution for Use

- Increase in reverse leakage current lowered turn-on voltage
- Abnormal emissions from the LED at low current

The following recommendations are suggested to help minimize the potential for an ESD event. One or more recommended work area suggestions:

- Ionizing fan setup
- ESD table/shelf mat made of conductive materials
- ESD safe storage containers

One or more personnel suggestion options:

- Antistatic wrist-strap
- Antistatic material shoes
- Antistatic clothes

Environmental controls:

- Humidity control (ESD gets worse in a dry environment)

b. EOS (Electrical Over Stress)

Electrical Over-Stress (EOS) is defined as damage that may occur when an electronic device is subjected to a current or voltage that is beyond the maximum specification limits of the device. The effects from an EOS event can be noticed through product performance like:

- Changes to the performance of the LED package (If the damage is around the bond pad area and since the package is completely encapsulated
- the package may turn on but flicker show severe performance degradation.)
- Changes to the light output of the luminaire from component failure
- Components on the board not operating at determined drive power

Failure of performance from entire fixture due to changes in circuit voltage and current across total circuit causing trickle down failures. It is impossible to predict the failure mode of every LED exposed to electrical overstress as the failure modes have been investigated to vary, but there are some common signs that will indicate an EOS event has occurred:

- Damaged may be noticed to the bond wires (appearing similar to a blown fuse)
- Damage to the bond pads located on the emission surface of the LED package (shadowing can be noticed around the bond pads while viewing through a microscope)
- Anomalies noticed in the encapsulation and phosphor around the bond wires
- This damage usually appears due to the thermal stress produced during the EOS event
- c. To help minimize the damage from an EOS event Seoul Semiconductor recommends utilizing:
 - A surge protection circuit
 - An appropriately rated over voltage protection device
 - A current limiting device



Company Information

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Company Information

Seoul Semiconductor (www.SeoulSemicon.com) manufacturers and packages a wide selection of light emitting diodes (LEDs) for the automotive, general illumination/lighting, Home appliance, signage and back lighting markets. The company is the world's fifth largest LED supplier, holding more than 10,000 patents globally, while offering a wide range of LED technology and production capacity in areas such as "nPola", "Acrich", the world's first commercially produced AC LED, and "Acrich MJT - Multi-Junction Technology" a proprietary family of high-voltage LEDs.

The company's broad product portfolio includes a wide array of package and device choices such as Acrich and Acirch2, high-brightness LEDs, mid-power LEDs, side-view LEDs, and through-hole type LEDs as well as custom modules, displays, and sensors.

Legal Disclaimer

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